



#### 1 Document

#### **Revision History**

Version	Date	Comments
100		Initial Release

#### Scope

This document summarizes the key differences between the Lepton 2 and Lepton 3 camera modules. It is intended primarily for users familiar with Lepton 2 who are considering Lepton 3 as an upgrade. It is divided into 9 sections:

- Summary
- <u>Electrical Interface</u>
- Command and Control Interface (CCI)
- Video Interface
- Feature Set
- Performance
- Mechanical
- Environmental
- Frequently-Asked Questions



### Summary

The primary difference between Lepton 2 and Lepton 3 is the improved resolution of the infrared sensor. Lepton 2 provides an output of 80x60 pixels whereas Lepton 3 outputs 160x120. Despite having four times the number of pixels, Lepton 3 maintains the form factor of its predecessor and consumes only slightly more power (nominally 160 mW versus 150 mW). A key enabler for allowing improved resolution without a substantial growth in camera size is reduction of pixel pitch from 17 to 12 microns.

#### **Electrical Interface**

Generally speaking, the electrical interface to Lepton 3 is identical to Lepton 2. It is intended to be installed in the same socket (Molex 1052028-1001 or Molex 105028-2031), and the pinout is unchanged. All DC and logic levels, all AC characteristics, and all absolute maximum ratings are identical to Lepton 2 (with the possible exception of the VoSPI clock frequency, as described in the video interface section). As noted in the Summary section, power consumption of Lepton 3 is nominally 10 mW higher (160 mW vs. 150 mW).

### **Command and Control Interface (CCI)**

Lepton 2 and 3 share a common CCI, a two-wire interface very similar to I2C (the difference relative to the true I2C standard being that only 16-bit transfers are allowed). Both Lepton 2 and Lepton 3 use the same I2C address (0x2A), and Lepton 3 is fully backward compatible with the Lepton 2 command set. The document which defines the interface in detail, the Software Interface Description Document (IDD), is common to the two versions of Lepton, as is the Software Development Kit (SDK).

#### Video Interface

Considering that Lepton 3 outputs four times as many pixels as Lepton 2, it is not surprising that the biggest differences between the two modules are in the Video-Over-SPI (VoSPI) interface. That said, much of the interface is unchanged, as summarized below.

- 1) The VoSPI physical layer is identical, including the SPI mode and timing.
- 2) For both modules, the minimum VoSPI transaction is a packet consisting of



either 164 bytes of data (Raw14 video mode) or 244 (RGB888 mode). The packet protocol, including the packet header and payload, are unchanged. However, it is worth noting a single packet represents a single 80-pixel video line for Lepton 2 whereas it represents half of a 160-pixel video line in Lepton 3

- 3) The synchronization requirements are identical with one exception. To maintain synchronization, Lepton 2 requires each video frame to be read out prior to the next available frame. Conversely, Lepton 3 requires each segment to be read out prior to the next available segment, where a segment represents one-quarter of a video frame.
- 4) For both Lepton 2 and Lepton 3, each unique video frame is duplicated twice. The duplicate frames must be read out to maintain synchronization.

The four most significant differences between the Lepton 2 VoSPI interface and that for Lepton 3 are:

- 1) On Lepton 2, reconstructing a video frame from the individual packets requires the host to decode the packet number from each packet header. On Lepton 3, the host must decode both the packet number and the segment number.
- The total number of bits per frame is 4X greater for Lepton 3 than for Lepton
  Consequently, the minimum SPI clock rate is 4X faster. The maximum SPI clock rate for both modules is 20 MHz.
- 3) Both Lepton 2 and Lepton 3 provide the option to output a sync pulse on GPIO3. The frequency of the pulse is 4X higher on Lepton 3 than on Lepton 2. For Lepton 3, the sync pulse represents when the next available segment is available to be read whereas for Lepton 2 it indicates when the next available frame is available.
- 4) When telemetry is enabled in Lepton 2, it results in three extra video lines (63 total packets per frame). When telemetry is enabled in Lepton 3, it results in 1 additional packet per segment for a total of 2 extra video lines per frame.

A careful review of the VoSPI section of the Lepton 3 datasheet is recommended for a more complete understanding of the video interface.

#### **Feature Set**



The Lepton 3 feature set is identical to that of Lepton 2 with two exceptions:

- 1) Lepton 3 provides a new command called "Set User Defaults"
- 2) Lepton 3 includes an improved AGC algorithm.

#### **Set User Defaults Feature**

This "Set User Defaults" feature allows the user to store a customized set of parameter settings as power-on defaults. It is intended that the command is sent after the module has been configured to all desired parameter settings (such as whether to output Raw14 data or RGB888 data). Once the parameter defaults are stored, they will take affect at every subsequent power-up and/or reset event. This feature allows the customer to customize Lepton cameras in a factory environment prior to installation in the end system. Depending upon the application, this capability might prevent the end system from requiring a Command and Control Interface between Lepton and host. Note that "Set User Defaults" can only be sent once. The module will report an error if the command is sent a second time.

#### **Improved AGC**

[cut & paste from Julie's AGC section in the datasheet]

#### **Performance**

Other than the obvious benefit of providing 4 times the pixel resolution, the performance specifications of Lepton 3 are very similar to Lepton 2.

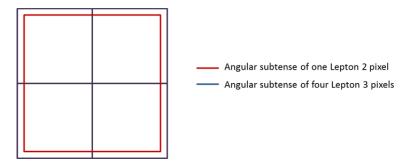
<u>NEDT</u>: Both products have a specified Noise Equivalent Delta Temperature (NEDT) less than 50 mK. (NEDT refers to the thermal resolution of the product. An NEDT of 50 mK means that when the temperature difference between two objects is 50 mK, the signal-to-noise ratio is unity.)

<u>Field of View</u>: The nominal field of view (FOV) of Lepton 3 is slightly wider than that of Lepton 2, as summarized below.

	Horizontal FOV	Vertical FOV	Diagonal FOV
Lepton 2	51 degrees	38 degrees	64 degrees
Lepton 3	56 degrees	42 degrees	71 degrees



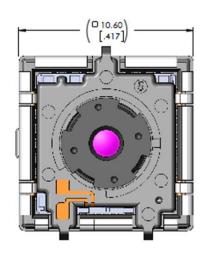
<u>Operability</u>: Both Lepton 2 and Lepton 3 provide operability ≥99% (i.e., less than 1% of the pixels are defective). In both products, all defects are replaced by the average of non-defective neighbors. Lepton 3 allows two-pixel clusters, but it is worth noting that the angular subtense of a two-pixel cluster in Lepton 3 is nearly half the angular subtense of a single defect in Lepton 2. This fact is illustrated in the figure below.

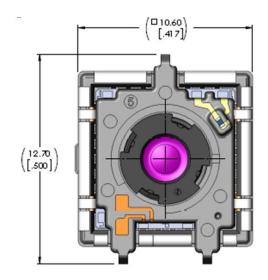


#### Mechanical

Generally speaking, the mechanical interface to Lepton 3 is very similar to Lepton 2. The three figures below show Lepton 2 on the left, Lepton 3 on the right. The first two show the cross-section of the shutterless and shuttered configurations, respectively, and the third compares the height. As described in the Electrical section, both are intended to be installed in the same socket.

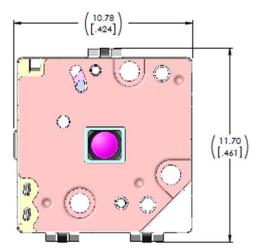


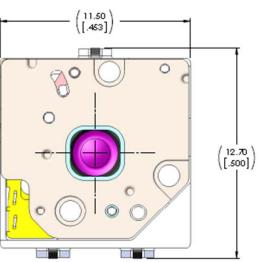




(a) Lepton 2

pton 2 (b) Lepton 3

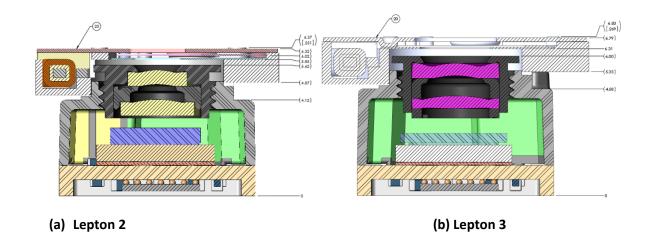




(a) Lepton 2

(b) Lepton 3





#### **Environmental**

The same environmental requirements specified for Lepton 2 also apply to Lepton 3. These are summarized below.

Stress	Maximum Rating
Operating Temperature Range	-10° C to 65° C
	(-20° C to 75° C with some possible performance degradation)
Maximum Operating Temperature	80 °C¹
Shutter Operating Temperature	-10° C to 65° C <sup>2</sup>
Storage Temperature	-40° C to 80° C
Altitude (pressure)	12 km altitude equivalent
Relative Humidity	95%
Thermal Shock	Air-to-air across operating temp. extremes (-10° C to 65° C, 65° C to -10° C)
Mechanical Shock	1500 g, 0.4 msec
Vibration	Transportation profile, 4.3 grms



ESD	Human Body Model (HBM), 2kV
	Charged Device Model (CDM), 500V

#### Note(s)

- 1. Both Lepton 2 and Lepton 3 contain an automatic shutdown feature when its internal temperature exceeds the maximum safe operating value.
- 2. Both Lepton 2 and Lepton 3 contain an automatic shutter lockout feature that prevents the shutter from operating when its internal temperature is outside the range of -10° C to 65° C.



[Is this section required? Basically reformat all of the information described above into Q&A form?]

### **Frequently-Asked Questions**

#### **Electrical Interface**

Q. tbd

A. tbd



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